

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition
1	BRS	L1	694	(aqueous same nonaqueous) and (cmp or ((chemical\$2 mechanical\$2) adj (polish\$3 or planariz\$5)) or polish\$3 or planariz\$5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2005/09/06 12:02		
2	BRS	L2	378	1 and @pd<="20010830"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2005/09/06 12:03		
3	BRS	L3	0	2 and 438/692	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2005/09/06 11:31		
4	BRS	L4	0	2 and "438"/\$ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2005/09/06 11:32		
5	BRS	L5	5	2 and "438"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2005/09/06 12:02		
6	BRS	L6	146	(aqueous same nonaqueous) and (cmp or ((chemical\$2 mechanical\$2) adj (polish\$3 or planariz\$5)) or polish\$3 or planariz\$5) and (semiconductor or substrate and wafer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2005/09/06 12:03		
7	BRS	L7	46	6 and @pd<="20010830"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2005/09/06 12:00		
8	BRS	L8	5	7 and "438"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2005/09/06 12:04		

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition
9	BRS	L9	0	8 not 5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2005/09/06 12:02		
10	BRS	L10	250	((aqueous same nonaqueous) with (solvent or slurry)) and (cmp or ((chemical\$2 mechanical\$2) adj (polish\$3 or planariz\$5)) or polish\$3 or planariz\$5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2005/09/06 12:03		
11	BRS	L11	118	10 and @pd<="20010830"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2005/09/06 12:03		
12	BRS	L12	63	10 and (semiconductor or substrate and wafer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2005/09/06 12:03		
13	BRS	L13	22	12 and @pd<="20010830"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2005/09/06 12:03		
14	BRS	L14	1	13 and "438"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	2005/09/06 12:04		